BRIGHT LED ELECTRONICS CORP.

Specification for Approval

- **DEVICE NUMBER: BA-5Y5UD**

SAMPLES ATTACHED AREA

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2015/5/5	1.0	1.0	1.0	1.0							Initial Released

FOR CUSTOMER'S APPROVAL STAMP OR SIGNATURE

APPROVED	PURCHASE	MANUFACTURE	QUALITY	ENGINEERING

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ISSUED	APPROVED	PREPARED
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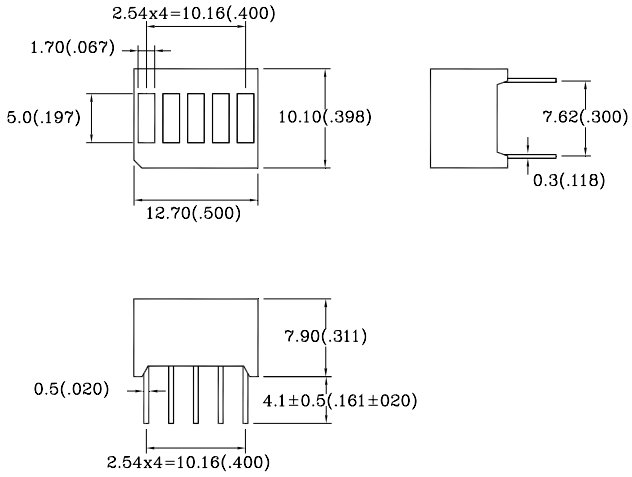
● Features :

1. Emitting area : 5.0×1.7×5（mm）
2. Low power requirement.
3. Excellent characters appearance.
4. Solid state reliability.
5. Categorized for luminous intensity.
6. Universal pin out.

● Description :

1. The BA-5Y5UD is 5 bar graph array display.
2. This product use yellow chips.
3. This product have a black face and white segments.
4. This product doesn't contain restriction substance, comply ROHS standard.

● Package Dimensions :



Notes:
1. All dimensions are in millimeters(inches).
2. Tolerance is ±0.25mm(.01")unless otherwise specified.
3. Specifications are subject to change without notice.

● Internal Circuit Diagram :

● Absolute Maximum Ratings(Ta=25℃)

Parameter	Symbol	Rating	Unit
Power Dissipation Per Segment	Pd	80	mW
Forward Current Per Segment	I_F	30	mA
Peak Forward Current Per Segment	I_{FP} (Duty 1/10, 1KHZ)	150	mA
Reverse Voltage Per Segment	V_R	5	V
Operating Temperature	Topr	-40℃~85℃	-
Storage Temperature	Tstg	-40℃~85℃	-

● Electrical And Optical Characteristics(Ta=25℃)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage Per Segment	Vf	I_F=10mA	-	2.0	2.5	V
Luminous Intensity Per Segment	Iv	I_F=10mA	-	3.0	-	mcd
Reverse Current Per Segment	I_R	V_R=5V	-	-	100	μA
Peak Wave Length	λp	I_F=20mA	-	589	-	nm
Dominant Wave Length	λd	I_F=20mA	585	-	594	nm
Spectral Line Half-width	Δλ	I_F=20mA	-	35	-	nm

● Typical Electro-Optical Characteristics Curves

(25℃ Ambient Temperature Unless Otherwise Noted)

Fig.1 Relative Radiant Intensity VS. Wavelength

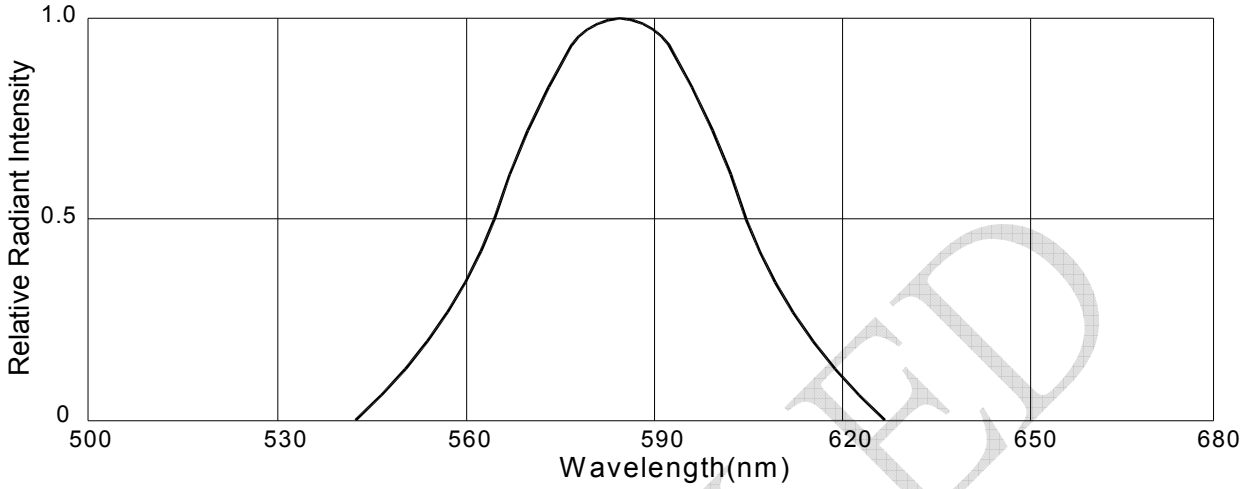


Fig.2 Forward Current VS. Forward Voltage

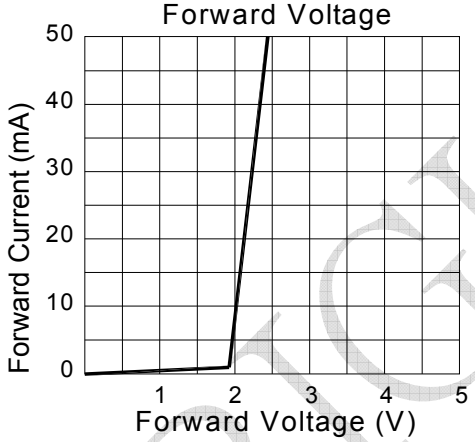


Fig.3 Relative Luminous Intensity VS. Ambient Temperature

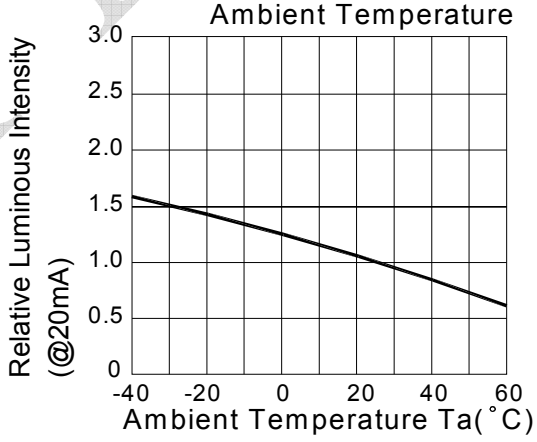


Fig.4 Relative Luminous Intensity VS. Forward Current

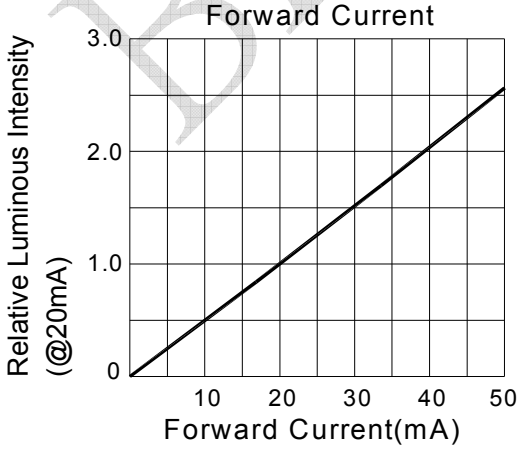
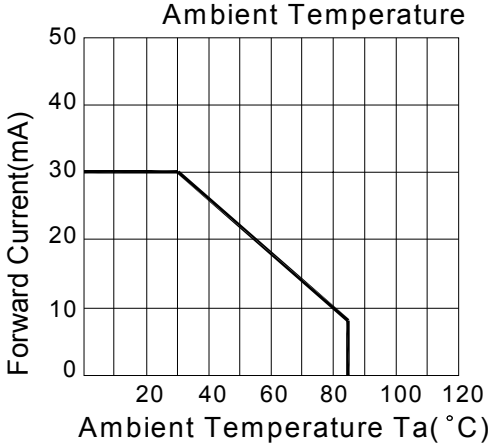
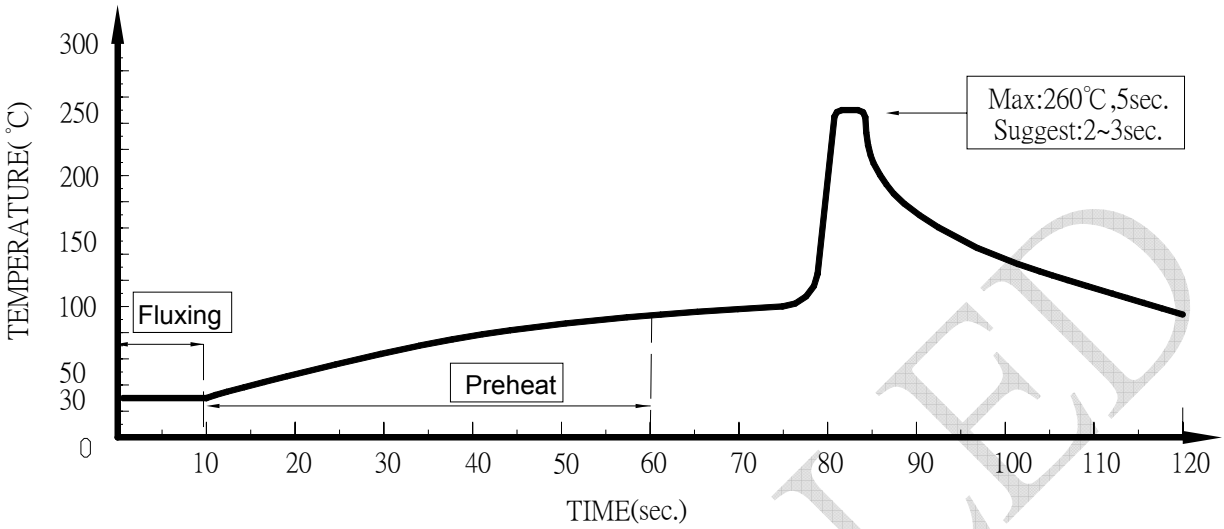


Fig.5 Forward Current Derating Curve VS. Ambient Temperature



● Dip Soldering



1. Please avoid any external stress applied to the lead-frames and epoxy while the LEDs are at high temperature,especially during soldering
2. DIP soldering and hand soldering should not be done more than one time.
3. After soldering, avoid the epoxy lens from mechanical shock or vibration until the LEDs are back to room temerature.
4. Avoid rapid cooling during temperature ramp-down process
5. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

● IRON Soldering

300℃ Within 3 sec.,One time only.